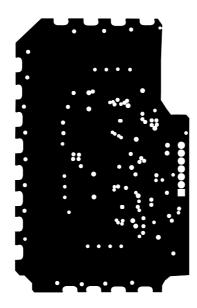
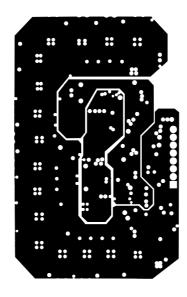


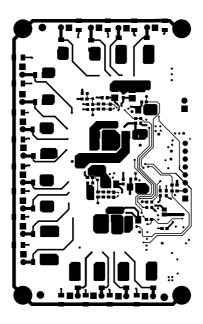
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SVN REV	: Not In VersionControl
LAYER NAME = Top Layer				
PLOT NAME = TIDA-00307_REV_E2.GTL	GENERATED : 9/18/2014	1:41:31	PM	TEXAS INSTRUMENTS



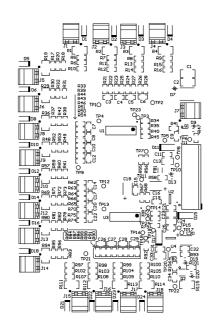
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SVN REV: Not In	VersionControl
LAYER NAME = L2_GND-PLANE				
PLOT NAME = TIDA-00307_REV_E2.G1	GENERATED : 9/18/2014	1:41:31	PM TEXAS	S INSTRUMENTS



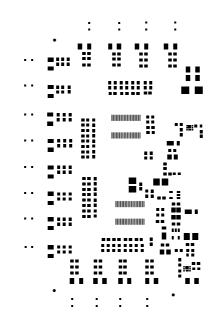
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SUN REV	: Not In VersionControl
LAYER NAME = L3_PWR-PLANE				
PLOT NAME = TIDA-00307_REV_E2.G2	GENERATED : 9/18/2014	1:41:31	PM	TEXAS INSTRUMENTS



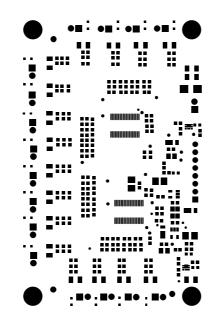
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SUN REU	: Not In VersionControl
LAYER NAME = Bottom Layer				
PLOT NAME = TIDA-00307_REV_E2.GBL	GENERATED : 9/18/2014	1:41:32	PM	TEXAS INSTRUMENTS



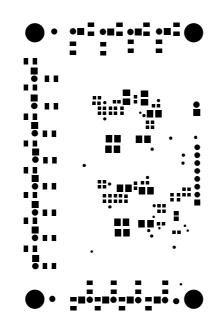
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = TIDA-00307_REV_E2.GTO	GENERATED : 9/18/2014	1:41:32	PM TEXAS INSTRUMENTS



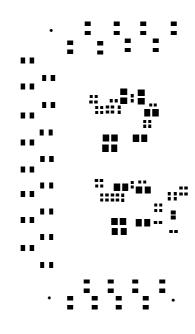
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Top Paste			
PLOT NAME = TIDA-00307_REV_E2.GTP	GENERATED : 9/18/2014	1:41:32	PM TEXAS INSTRUMENTS



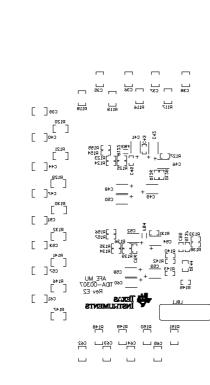
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SUN REV	: Not In VersionControl
LAYER NAME = Top Solder				
PLOT NAME = TIDA-00307_REV_E2.GTS	GENERATED : 9/18/2014	1:41:32	PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = TIDA-00307_REV_E2.GBS	GENERATED : 9/18/2014	1:41:32	PM TEXAS INSTRUMENTS

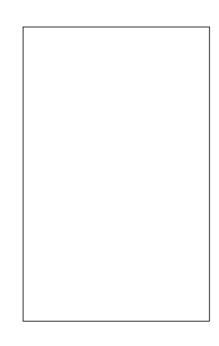


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SUN REU: N	Not In VersionControl
LAYER NAME = Bottom Paste				
PLOT NAME = TIDA-00307_REV_E2.GBP	GENERATED : 9/18/2014	1:41:32	PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SUN REU	:Not In VersionControl
LAYER NAME = Bottom Overlay				
PLOT NAME = TIDA-00307_REV_E2.GB0	GENERATED : 9/18/2014	1:41:32	PM	TEXAS INSTRUMENTS

CAMtasticDXP (TM): tida-00307_rev_e2.gm1



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00307	REV: E2	SUN REV:	Not In VersionControl
LAYER NAME = OUTLINE				
PLOT NAME = TIDA-00307_REV_E2.GM1	GENERATED : 9/18/2014	1:41:32	PM	TEXAS INSTRUMENTS

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